



5	6		
REV.	ECN NO OR DESCRIPTION	REVISED	DATE

技术要求:

- 1) 材质:见附表;
- 2) 电镀:见附表;
- 3) 塑件表面平整、光洁、无毛刺、气泡、烧焦、变形、浇口无拉伤、多料或缺料等不良现象;
- 4) 端子表面无氧化、电镀不良等现象。

适应基板厚度: 1.2mm~1.6mm

温度范围: -25℃~85℃

额定电压: 250V AC/DC

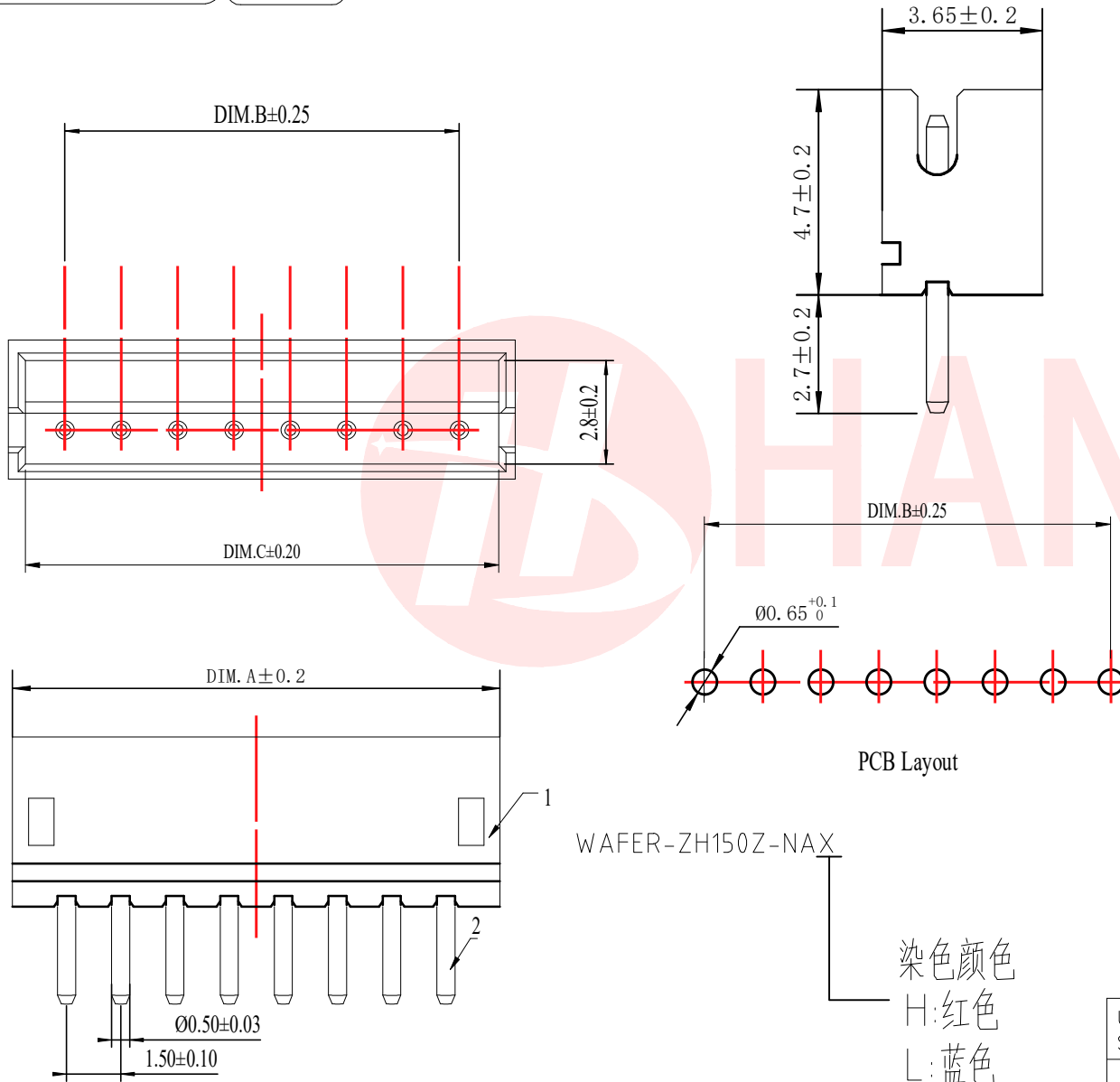
额定电流: 1A

绝缘电阻: ≥1000MΩ

耐 压: 800V AC/minute

TABLE:

CSG PART NO.	PIN位	A	B	C
WAFER-ZH150Z-2AX	2PIN	4.50	1.50	3.60
WAFER-ZH150Z-3AX	3PIN	6.00	3.00	5.10
WAFER-ZH150Z-4AX	4PIN	7.50	4.50	6.60
WAFER-ZH150Z-5AX	5PIN	9.00	6.00	8.10
WAFER-ZH150Z-6AX	6PIN	10.50	7.50	9.60
WAFER-ZH150Z-7AX	7PIN	12.00	9.00	11.10
WAFER-ZH150Z-8AX	8PIN	13.50	10.50	12.60
WAFER-ZH150Z-9AX	9PIN	15.00	12.00	14.10
WAFER-ZH150Z-10AX	10PIN	16.50	13.50	15.60
WAFER-ZH150Z-11AX	11PIN	18.00	15.00	17.10
WAFER-ZH150Z-12AX	12PIN	19.50	16.50	18.60



WAFER-ZH150Z-NAX

PCB Layout

染色颜色  
H:红色  
L:蓝色

2	PIN	n PCS	材质:黄铜,电镀:镀亮锡60u~MIN
1	Housing	1 PCS	材质:PA66 (UL94V-0),颜色:本色或黑色
NO.	NAME	Q'TY	DESCRIPTION

UNLESS OTHERWISE SPECIFIED TOLERANCES

DECIMALS:	ANGLES:
X :±0.35	X :±2°
X.X :±0.25	X.X :±1°
X.XX :±0.15	



东莞市汉博电子科技有限公司  
DONGGUAN HANBO TECHNOLOGY CO., LTD

TITLE	WAFER ZH 1.50 直针(红蓝颜色)		
DWN	xiong	PART NO.WAFER-ZH150Z-NAX	
CHKD	lee	SCALE:1:1	UNIT: mm
APVD	wang	SIZE: A4	SHEET:10F 1
REV: A4			
CUSTOMER COPY			